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#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	17
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1508t-i-ss

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#### 3.3 Data Memory Organization

The data memory is partitioned in 32 memory banks with 128 bytes in a bank. Each bank consists of (Figure 3-2):

- 12 core registers
- 20 Special Function Registers (SFR)
- Up to 80 bytes of General Purpose RAM (GPR)
- 16 bytes of common RAM

The active bank is selected by writing the bank number into the Bank Select Register (BSR). Unimplemented memory will read as '0'. All data memory can be accessed either directly (via instructions that use the file registers) or indirectly via the two File Select Registers (FSR). See **Section 3.6 "Indirect Addressing"** for more information.

Data memory uses a 12-bit address. The upper five bits of the address define the Bank address and the lower seven bits select the registers/RAM in that bank.

#### 3.3.1 CORE REGISTERS

The core registers contain the registers that directly affect the basic operation. The core registers occupy the first 12 addresses of every data memory bank (addresses x00h/x08h through x0Bh/x8Bh). These registers are listed below in Table 3-2. For detailed information, see Table 3-8.

TARI E 3-2.	CORE REGISTERS
IADLE J-Z.	CORE REGISTERS

Addresses	BANKx
x00h or x80h	INDF0
x01h or x81h	INDF1
x02h or x82h	PCL
x03h or x83h	STATUS
x04h or x84h	FSR0L
x05h or x85h	FSR0H
x06h or x86h	FSR1L
x07h or x87h	FSR1H
x08h or x88h	BSR
x09h or x89h	WREG
x0Ah or x8Ah	PCLATH
0Bh or x8Bh	INTCON

#### CDE CIAL FUNC

TABLE	: 3-9: 5			N REGIS	1ER 301						
Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Banks	14-29		•	•		•					<u>.</u>
x0Ch/ x8Ch	_	Unimplemen	ited							_	-
x1Fh/ x9Fh											
Bank 3	30										
F0Ch to F0Eh	_	Unimplemen	ited							_	-
F0Fh	CLCDATA	_	_	_	_	MLC4OUT	MLC3OUT	MLC2OUT	MLC1OUT	0000	0000
F10h	CLC1CON	LC1EN	LC10E	LC10UT	LC1INTP	LC1INTN		LC1MODE<2	:0>	0000 0000	0000 0000
F11h	CLC1POL	LC1POL	_	_	_	LC1G4POL	LC1G3POL	LC1G2POL	LC1G1POL	0 xxxx	0 uuuu
F12h	CLC1SEL0	_	L	_C1D2S<2:0	>	_		LC1D1S<2:0	)>	-xxx -xxx	-uuu -uuu
F13h	CLC1SEL1	_	L	_C1D4S<2:0	>	_		LC1D3S<2:0	)>	-xxx -xxx	-uuu -uuu
F14h	CLC1GLS0	LC1G1D4T	LC1G1D4N	LC1G1D3T	LC1G1D3N	LC1G1D2T	LC1G1D2N	LC1G1D1T	LC1G1D1N	xxxx xxxx	uuuu uuuu
F15h	CLC1GLS1	LC1G2D4T	LC1G2D4N	LC1G2D3T	LC1G2D3N	LC1G2D2T	LC1G2D2N	LC1G2D1T	LC1G2D1N	xxxx xxxx	uuuu uuuu
F16h	CLC1GLS2	LC1G3D4T	LC1G3D4N	LC1G3D3T	LC1G3D3N	LC1G3D2T	LC1G3D2N	LC1G3D1T	LC1G3D1N	xxxx xxxx	uuuu uuuu
F17h	CLC1GLS3	LC1G4D4T	LC1G4D4N	LC1G4D3T	LC1G4D3N	LC1G4D2T	LC1G4D2N	LC1G4D1T	LC1G4D1N	xxxx xxxx	uuuu uuuu
F18h	CLC2CON	LC2EN	LC2OE	LC2OUT	LC2INTP	LC2INTN		LC2MODE<2	:0>	0000 0000	0000 0000
F19h	CLC2POL	LC2POL	—	—	—	LC2G4POL	LC2G3POL	LC2G2POL	LC2G1POL	0 xxxx	0 uuuu
F1Ah	CLC2SEL0	—	L	_C2D2S<2:0	>	—		LC2D1S<2:0	)>	-xxx -xxx	-uuu -uuu
F1Bh	CLC2SEL1	—	L	_C2D4S<2:0	>	—		LC2D3S<2:0	)>	-xxx -xxx	-uuu -uuu
F1Ch	CLC2GLS0	LC2G1D4T	LC2G1D4N	LC2G1D3T	LC2G1D3N	LC2G1D2T	LC2G1D2N	LC2G1D1T	LC2G1D1N	xxxx xxxx	uuuu uuuu
F1Dh	CLC2GLS1	LC2G2D4T	LC2G2D4N	LC2G2D3T	LC2G2D3N	LC2G2D2T	LC2G2D2N	LC2G2D1T	LC2G2D1N	xxxx xxxx	uuuu uuuu
F1Eh	CLC2GLS2	LC2G3D4T	LC2G3D4N	LC2G3D3T	LC2G3D3N	LC2G3D2T	LC2G3D2N	LC2G3D1T	LC2G3D1N	XXXX XXXX	uuuu uuuu
F1Fh	CLC2GLS3	LC2G4D4T	LC2G4D4N	LC2G4D3T	LC2G4D3N	LC2G4D2T	LC2G4D2N	LC2G4D1T	LC2G4D1N	XXXX XXXX	uuuu uuuu
F20h	CLC3CON	LC3EN	LC3OE	LC3OUT	LC3INTP	LC3INTN		LC3MODE<2	:0>	0000 0000	0000 0000
F21h	CLC3POL	LC3POL	-	—	—	LC3G4POL	LC3G3POL	LC3G2POL	LC3G1POL	0 xxxx	0 uuuu
F22h	CLC3SEL0	—	L	_C3D2S<2:0	>	-		LC3D1S<2:0	)>	-xxx -xxx	-uuu -uuu
F23h	CLC3SEL1	—	L	_C3D4S<2:0	>	—		LC3D3S<2:0	)>	-xxx -xxx	-uuu -uuu
F24h	CLC3GLS0	LC3G1D4T	LC3G1D4N	LC3G1D3T	LC3G1D3N	LC3G1D2T	LC3G1D2N	LC3G1D1T	LC3G1D1N	XXXX XXXX	uuuu uuuu
F25h	CLC3GLS1	LC3G2D4T	LC3G2D4N	LC3G2D3T	LC3G2D3N	LC3G2D2T	LC3G2D2N	LC3G2D1T	LC3G2D1N	XXXX XXXX	uuuu uuuu
F26h	CLC3GLS2	LC3G3D4T	LC3G3D4N	LC3G3D3T	LC3G3D3N	LC3G3D2T	LC3G3D2N	LC3G3D1T	LC3G3D1N	XXXX XXXX	uuuu uuuu
F27h	CLC3GLS3	LC3G4D4T	LC3G4D4N	LC3G4D3T	LC3G4D3N	LC3G4D2T	LC3G4D2N	LC3G4D1T	LC3G4D1N	XXXX XXXX	uuuu uuuu
F28h	CLC4CON	LC4EN	LC40E	LC40UT	LC4INTP	LC4INTN		LC4MODE<2	:0>	0000 0000	0000 0000
F29h	CLC4POL	LC4POL	-	—	—	LC4G4POL	LC4G3POL	LC4G2POL	LC4G1POL	0 xxxx	0 uuuu
F2Ah	CLC4SEL0	_	L	_C4D2S<2:0	>	_		LC4D1S<2:0	)>	-xxx -xxx	-uuu -uuu
F2Bh	CLC4SEL1	—		_C4D4S<2:0		—		LC4D3S<2:0	)>	-xxx -xxx	-uuu -uuu
F2Ch	CLC4GLS0	LC4G1D4T	LC4G1D4N	LC4G1D3T	LC4G1D3N	LC4G1D2T	LC4G1D2N	LC4G1D1T	LC4G1D1N	XXXX XXXX	uuuu uuuu
F2Dh	CLC4GLS1	LC4G2D4T	LC4G2D4N	LC4G2D3T	LC4G2D3N	LC4G2D2T	LC4G2D2N	LC4G2D1T	LC4G2D1N	XXXX XXXX	uuuu uuuu
F2Eh	CLC4GLS2	LC4G3D4T	LC4G3D4N	LC4G3D3T	LC4G3D3N	LC4G3D2T	LC4G3D2N	LC4G3D11	LC4G3D1N	XXXX XXXX	uuuu uuuu
F2Fh	CLC4GLS3	LC4G4D4T	LC4G4D4N	LC4G4D3T	LC4G4D3N	LC4G4D2T	LC4G4D2N	LC4G4D1T	LC4G4D1N	XXXX XXXX	uuuu uuuu
F20h	CLC3CON	LC3EN	LC30E	LC3OUT	LC3INTP	LC3INTN	1.00000000	LC3MODE<2	:U>	0000 0000	0000 0000
F21h	CLC3POL	LC3POL	—	-	-	LC3G4POL	LC3G3POL	LC3G2POL	LC3G1POL	U xxxx	0 uuuu
F2Fh	CLC4GLS3	LC4G4D4T	LC4G4D4N	LC4G4D3T	LC4G4D3N	LC4G4D2T	LC4G4D2N	LC4G4D1T	LC4G4D1N	XXXX XXXX	uuuu uuuu
F30h to F6Fh	-	Unimplemen	ited							-	-

 Legend:
 x = unknown, u = unchanged, g = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

 Note
 1:
 PIC16F1508/9 only.

 2:
 Unimplemented, read as '1'.



#### 3.6.2 LINEAR DATA MEMORY

The linear data memory is the region from FSR address 0x2000 to FSR address 0x29AF. This region is a virtual region that points back to the 80-byte blocks of GPR memory in all the banks.

Unimplemented memory reads as 0x00. Use of the linear data memory region allows buffers to be larger than 80 bytes because incrementing the FSR beyond one bank will go directly to the GPR memory of the next bank.

The 16 bytes of common memory are not included in the linear data memory region.

FIGURE 3-10: LINEAR DATA MEMORY MAP



#### 3.6.3 PROGRAM FLASH MEMORY

To make constant data access easier, the entire program Flash memory is mapped to the upper half of the FSR address space. When the MSb of FSRnH is set, the lower 15 bits are the address in program memory which will be accessed through INDF. Only the lower eight bits of each memory location is accessible via INDF. Writing to the program Flash memory cannot be accomplished via the FSR/INDF interface. All instructions that access program Flash memory via the FSR/INDF interface will require one additional instruction cycle to complete.

#### FIGURE 3-11: PROGRAM FLASH MEMORY MAP



#### 11.1 Alternate Pin Function

The Alternate Pin Function Control (APFCON) register is used to steer specific peripheral input and output functions between different pins. The APFCON register is shown in Register 11-1. For this device family, the following functions can be moved between different pins.

- <u>ss</u>
- T1G
- CLC1
- NCO1

bit 0

# These bits have no effect on the values of any TRIS register. PORT and TRIS overrides will be routed to the correct pin. The unselected pin will be unaffected.

#### 11.2 Register Definitions: Alternate Pin Function Control

#### **REGISTER 11-1:** APFCON: ALTERNATE PIN FUNCTION CONTROL REGISTER

U-0	U-0	U-0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0
_	_	—	SSSEL	T1GSEL	_	CLC1SEL	NCO1SEL
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplen	nented bit, read	as '0'	
u = Bit is unch	anged	x = Bit is unkr	nown	-n/n = Value a	t POR and BO	R/Value at all of	ther Resets
'1' = Bit is set		'0' = Bit is clea	ared				
bit 7-5	Unimplemen	ted: Read as '	0'				
bit 4	SSSEL: Pin S	Selection bit					
	1 = SS funct	tion is on RA3					
	$0 = \overline{SS}$ function is on RC6						
bit 3	T1GSEL: Pin	Selection bit					
	1 = T1G fun	ction is on RA3	3				
	0 = T1G function is on RA4						
bit 2	Unimplemen	ted: Read as '	0'				
bit 1	CLC1SEL: Pin Selection bit						
	1 = CLC1 fu	nction is on RC	C5				

- 0 = CLC1 function is on RA2
- **NCO1SEL:** Pin Selection bit 1 = NCO1 function is on RC6
  - 0 = NCO1 function is on RC1

#### **15.1 ADC Configuration**

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
- ADC voltage reference selection
- ADC conversion clock source
- Interrupt control
- · Result formatting

#### 15.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin should be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 11.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined					
	as a digital input may cause the input					
	buffer to conduct excess current.					

#### 15.1.2 CHANNEL SELECTION

There are 15 channel selections available:

- AN<11:0> pins
- · Temperature Indicator
- DAC1\_output
- FVR buffer1

The CHS bits of the ADCON0 register determine which channel is connected to the sample and hold circuit.

When changing channels, a delay (TACQ) is required before starting the next conversion. Refer to **Section 15.2.6 "ADC Conversion Procedure"** for more information.

#### 15.1.3 ADC VOLTAGE REFERENCE

The ADC module uses a positive and a negative voltage reference. The positive reference is labeled ref+ and the negative reference is labeled ref-.

The positive voltage reference (ref+) is selected by the ADPREF bits in the ADCON1 register. The positive voltage reference source can be:

- VREF+ pin
- Vdd

The negative voltage reference (ref-) source is:

Vss

#### 15.1.4 CONVERSION CLOCK

The source of the conversion clock is software selectable via the ADCS bits of the ADCON1 register. There are seven possible clock options:

- Fosc/2
- Fosc/4
- Fosc/8
- Fosc/16
- Fosc/32
- Fosc/64
- · FRC (internal RC oscillator)

The time to complete one bit conversion is defined as TAD. One full 10-bit conversion requires 11.5 TAD periods as shown in Figure 15-2.

For correct conversion, the appropriate TAD specification must be met. Refer to the ADC conversion requirements in **Section 29.0 "Electrical Specifications"** for more information. Table 15-1 gives examples of appropriate ADC clock selections.

**Note:** Unless using the FRC, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.

#### 18.0 TIMER0 MODULE

The Timer0 module is an 8-bit timer/counter with the following features:

- 8-bit timer/counter register (TMR0)
- 3-bit prescaler (independent of Watchdog Timer)
- · Programmable internal or external clock source
- Programmable external clock edge selection
- Interrupt on overflow

TMR0CS

· TMR0 can be used to gate Timer1

Figure 18-1 is a block diagram of the Timer0 module.

#### 18.1 Timer0 Operation

The Timer0 module can be used as either an 8-bit timer or an 8-bit counter.

#### 18.1.1 8-BIT TIMER MODE

The Timer0 module will increment every instruction cycle, if used without a prescaler. 8-bit Timer mode is selected by clearing the TMR0CS bit of the OPTION REG register.

When TMR0 is written, the increment is inhibited for two instruction cycles immediately following the write.

**Note:** The value written to the TMR0 register can be adjusted, in order to account for the two instruction cycle delay when TMR0 is written.

#### FIGURE 18-1: TIMER0 BLOCK DIAGRAM

#### 18.1.2 8-BIT COUNTER MODE

In 8-Bit Counter mode, the Timer0 module will increment on every rising or falling edge of the T0CKI pin.

8-Bit Counter mode using the T0CKI pin is selected by setting the TMR0CS bit in the OPTION\_REG register to '1'.

The rising or falling transition of the incrementing edge for either input source is determined by the TMR0SE bit in the OPTION\_REG register.



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#### 19.3 Timer1 Prescaler

Timer1 has four prescaler options allowing 1, 2, 4 or 8 divisions of the clock input. The T1CKPS bits of the T1CON register control the prescale counter. The prescale counter is not directly readable or writable; however, the prescaler counter is cleared upon a write to TMR1H or TMR1L.

#### 19.4 Timer1 (Secondary) Oscillator

A dedicated low-power 32.768 kHz oscillator circuit is built-in between pins SOSCI (input) and SOSCO (amplifier output). This internal circuit is to be used in conjunction with an external 32.768 kHz crystal. The oscillator circuit is enabled by setting the T1OSCEN bit of the T1CON register. The oscillator will continue to run during Sleep.

Note: The oscillator requires some time to start-up and stabilize before use. The SOSCR bit in the OSCSTAT register monitors the oscillator and indicates when the oscillator is ready for use. When T1OSCEN is set, the SOSCR bit is cleared. After 1024 cycles of the oscillator are countered, the SOSCR bit is set, indicating that the oscillator should be stable and ready for use.

#### 19.5 Timer1 Operation in Asynchronous Counter Mode

If control bit T1SYNC of the T1CON register is set, the external clock input is not synchronized. The timer increments asynchronously to the internal phase clocks. If the external clock source is selected then the timer will continue to run during Sleep and can generate an interrupt on overflow, which will wake-up the processor. However, special precautions in software are needed to read/write the timer (see Section 19.5.1 "Reading and Writing Timer1 in Asynchronous Counter Mode").

Note:	When switching from synchronous to
	asynchronous operation, it is possible to
	skip an increment. When switching from
	asynchronous to synchronous operation,
	it is possible to produce an additional
	increment.

#### 19.5.1 READING AND WRITING TIMER1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L while the timer is running from an external asynchronous clock will ensure a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself, poses certain problems, since the timer may overflow between the reads. For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers, while the register is incrementing. This may produce an unpredictable value in the TMR1H:TMR1L register pair.

#### 19.6 Timer1 Gate

Timer1 can be configured to count freely or the count can be enabled and disabled using Timer1 gate circuitry. This is also referred to as Timer1 Gate Enable.

Timer1 gate can also be driven by multiple selectable sources.

#### 19.6.1 TIMER1 GATE ENABLE

The Timer1 Gate Enable mode is enabled by setting the TMR1GE bit of the T1GCON register. The polarity of the Timer1 Gate Enable mode is configured using the T1GPOL bit of the T1GCON register.

When Timer1 Gate Enable mode is enabled, Timer1 will increment on the rising edge of the Timer1 clock source. When Timer1 Gate Enable mode is disabled, no incrementing will occur and Timer1 will hold the current count. See Figure 19-3 for timing details.

### TABLE 19-3: TIMER1 GATE ENABLE SELECTIONS

T1CLK	T1GPOL	T1G	Timer1 Operation
1	0	0	Counts
$\uparrow$	0	1	Holds Count
$\uparrow$	1	0	Holds Count
$\uparrow$	1	1	Counts

#### 19.6.2 TIMER1 GATE SOURCE SELECTION

Timer1 gate source selections are shown in Table 19-4. Source selection is controlled by the T1GSS<1:0> bits of the T1GCON register. The polarity for each available source is also selectable. Polarity selection is controlled by the T1GPOL bit of the T1GCON register.

TABLE 19-4:	TIMER1 GA	<b>ATE SOURCES</b>
-------------	-----------	--------------------

T1GSS	Timer1 Gate Source
00	Timer1 Gate pin (T1G)
01	Overflow of Timer0 (T0_overflow) (TMR0 increments from FFh to 00h)
10	Comparator 1 Output (C1OUT_sync) <sup>(1)</sup>
11	Comparator 2 Output (C2OUT_sync) <sup>(1)</sup>
N / /	

Note 1: Optionally synchronized comparator output.

#### 19.6.2.1 T1G Pin Gate Operation

The T1G pin is one source for Timer1 gate control. It can be used to supply an external source to the Timer1 gate circuitry.

#### 19.6.2.2 Timer0 Overflow Gate Operation

When Timer0 increments from FFh to 00h, a low-tohigh pulse will automatically be generated and internally supplied to the Timer1 gate circuitry.

#### 19.6.3 TIMER1 GATE TOGGLE MODE

When Timer1 Gate Toggle mode is enabled, it is possible to measure the full-cycle length of a Timer1 gate signal, as opposed to the duration of a single level pulse.

The Timer1 gate source is routed through a flip-flop that changes state on every incrementing edge of the signal. See Figure 19-4 for timing details.

Timer1 Gate Toggle mode is enabled by setting the T1GTM bit of the T1GCON register. When the T1GTM bit is cleared, the flip-flop is cleared and held clear. This is necessary in order to control which edge is measured.

**Note:** Enabling Toggle mode at the same time as changing the gate polarity may result in indeterminate operation.

#### 19.6.4 TIMER1 GATE SINGLE-PULSE MODE

When Timer1 Gate Single-Pulse mode is enabled, it is possible to capture a single pulse gate event. Timer1 Gate Single-Pulse mode is first enabled by setting the T1GSPM bit in the T1GCON register. Next, the T1GGO/ DONE bit in the T1GCON register must be set. The Timer1 will be fully enabled on the next incrementing edge. On the next trailing edge of the pulse, the T1GGO/ DONE bit will automatically be cleared. No other gate events will be allowed to increment Timer1 until the T1GGO/DONE bit is once again set in software. See Figure 19-5 for timing details.

If the Single Pulse Gate mode is disabled by clearing the T1GSPM bit in the T1GCON register, the T1GGO/DONE bit should also be cleared.

Enabling the Toggle mode and the Single-Pulse mode simultaneously will permit both sections to work together. This allows the cycle times on the Timer1 gate source to be measured. See Figure 19-6 for timing details.

#### 19.6.5 TIMER1 GATE VALUE STATUS

When Timer1 Gate Value Status is utilized, it is possible to read the most current level of the gate control value. The value is stored in the T1GVAL bit in the T1GCON register. The T1GVAL bit is valid even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

#### 19.6.6 TIMER1 GATE EVENT INTERRUPT

When Timer1 Gate Event Interrupt is enabled, it is possible to generate an interrupt upon the completion of a gate event. When the falling edge of T1GVAL occurs, the TMR1GIF flag bit in the PIR1 register will be set. If the TMR1GIE bit in the PIE1 register is set, then an interrupt will be recognized.

The TMR1GIF flag bit operates even when the Timer1 gate is not enabled (TMR1GE bit is cleared).

#### 21.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP) MODULE

#### 21.1 MSSP Module Overview

The Master Synchronous Serial Port (MSSPx) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSPx module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I<sup>2</sup>C<sup>™</sup>)

The SPI interface supports the following modes and features:

- Master mode
- Slave mode
- · Clock Parity
- Slave Select Synchronization (Slave mode only)
- Daisy-chain connection of slave devices

Figure 21-1 is a block diagram of the SPI interface module.



#### FIGURE 21-1: MSSP BLOCK DIAGRAM (SPI MODE)

#### 21.4 I<sup>2</sup>C MODE OPERATION

All MSSP I<sup>2</sup>C communication is byte oriented and shifted out MSb first. Six SFR registers and two interrupt flags interface the module with the PIC<sup>®</sup> microcontroller and user software. Two pins, SDAx and SCLx, are exercised by the module to communicate with other external I<sup>2</sup>C devices.

#### 21.4.1 BYTE FORMAT

All communication in  $I^2C$  is done in 9-bit segments. A byte is sent from a master to a slave or vice-versa, followed by an Acknowledge bit sent back. After the eighth falling edge of the SCLx line, the device outputting data on the SDAx changes that pin to an input and reads in an acknowledge value on the next clock pulse.

The clock signal, SCLx, is provided by the master. Data is valid to change while the SCLx signal is low, and sampled on the rising edge of the clock. Changes on the SDAx line while the SCLx line is high define special conditions on the bus, explained below.

#### 21.4.2 DEFINITION OF I<sup>2</sup>C TERMINOLOGY

There is language and terminology in the description of I<sup>2</sup>C communication that have definitions specific to I<sup>2</sup>C. That word usage is defined below and may be used in the rest of this document without explanation. This table was adapted from the Philips I<sup>2</sup>C<sup>TM</sup> specification.

#### 21.4.3 SDAX AND SCLX PINS

Selection of any I<sup>2</sup>C mode with the SSPEN bit set, forces the SCLx and SDAx pins to be open-drain. These pins should be set by the user to inputs by setting the appropriate TRIS bits.

Note: Data is tied to output zero when an I<sup>2</sup>C mode is enabled.

#### 21.4.4 SDAX HOLD TIME

The hold time of the SDAx pin is selected by the SDAHT bit of the SSPxCON3 register. Hold time is the time SDAx is held valid after the falling edge of SCLx. Setting the SDAHT bit selects a longer 300 ns minimum hold time and may help on buses with large capacitance.

#### TABLE 21-2: I<sup>2</sup>C BUS TERMS

TERM	Description
Transmitter	The device which shifts data out onto the bus.
Receiver	The device which shifts data in from the bus.
Master	The device that initiates a transfer, generates clock signals and termi- nates a transfer.
Slave	The device addressed by the master.
Multi-master	A bus with more than one device that can initiate data transfers.
Arbitration	Procedure to ensure that only one master at a time controls the bus. Winning arbitration ensures that the message is not corrupted.
Synchronization	Procedure to synchronize the clocks of two or more devices on the bus.
Idle	No master is controlling the bus, and both SDAx and SCLx lines are high.
Active	Any time one or more master devices are controlling the bus.
Addressed Slave	Slave device that has received a matching address and is actively being clocked by a master.
Matching Address	Address byte that is clocked into a slave that matches the value stored in SSPxADD.
Write Request	Slave receives a matching address with R/W bit clear, and is ready to clock in data.
Read Request	Master sends an address byte with the $R/\overline{W}$ bit set, indicating that it wishes to clock data out of the Slave. This data is the next and all following bytes until a Restart or Stop.
Clock Stretching	When a device on the bus hold SCLx low to stall communication.
Bus Collision	Any time the SDAx line is sampled low by the module while it is out- putting and expected high state.



#### TABLE 22-3: BAUD RATE FORMULAS

Configuration Bits				Boud Bote Fermula	
SYNC	BRG16	BRGH	BRG/EUSART Mode	Bauu Kale Formula	
0	0	0	8-bit/Asynchronous	Fosc/[64 (n+1)]	
0	0	1	8-bit/Asynchronous		
0	1	0	16-bit/Asynchronous	FOSC/[16 (n+1)]	
0	1	1	16-bit/Asynchronous		
1	0	x	8-bit/Synchronous	Fosc/[4 (n+1)]	
1	1	x	16-bit/Synchronous		

**Legend:** x = Don't care, n = value of SPBRGH, SPBRGL register pair.

#### TABLE 22-4: SUMMARY OF REGISTERS ASSOCIATED WITH THE BAUD RATE GENERATOR

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	_	WUE	ABDEN	235
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	234
SPBRGL	BRG<7:0>							236*	
SPBRGH	BRG<15:8>							236*	
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	233

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for the Baud Rate Generator.

\* Page provides register information.

### 22.5.2.3 EUSART Synchronous Slave Reception

The operation of the Synchronous Master and Slave modes is identical (Section22.5.1.5 "Synchronous Master Reception"), with the following exceptions:

- Sleep
- CREN bit is always set, therefore the receiver is never idle
- · SREN bit, which is a "don't care" in Slave mode

A character may be received while in Sleep mode by setting the CREN bit prior to entering Sleep. Once the word is received, the RSR register will transfer the data to the RCREG register. If the RCIE enable bit is set, the interrupt generated will wake the device from Sleep and execute the next instruction. If the GIE bit is also set, the program will branch to the interrupt vector.

- 22.5.2.4 Synchronous Slave Reception Set-up:
- 1. Set the SYNC and SPEN bits and clear the CSRC bit.
- 2. Clear the ANSEL bit for both the CK and DT pins (if applicable).
- 3. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
- 4. If 9-bit reception is desired, set the RX9 bit.
- 5. Set the CREN bit to enable reception.
- The RCIF bit will be set when reception is complete. An interrupt will be generated if the RCIE bit was set.
- 7. If 9-bit mode is enabled, retrieve the Most Significant bit from the RX9D bit of the RCSTA register.
- 8. Retrieve the eight Least Significant bits from the receive FIFO by reading the RCREG register.
- 9. If an overrun error occurs, clear the error by either clearing the CREN bit of the RCSTA register or by clearing the SPEN bit which resets the EUSART.

### TABLE 22-10: SUMMARY OF REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE RECEPTION RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	235
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	75
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	—	TMR2IE	TMR1IE	76
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	—	TMR2IF	TMR1IF	79
RCREG	EUSART Receive Data Register							228*	
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	234
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	113
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	233

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for synchronous slave reception.

\* Page provides register information.

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u			
LCxG2D4T	LCxG2D4N	LCxG2D3T	LCxG2D3N	LCxG2D2T	LCxG2D2N	LCxG2D1T	LCxG2D1N			
bit 7							bit 0			
Legend:										
R = Readable	bit	W = Writable	bit	U = Unimplemented bit, read as '0'						
u = Bit is unch	anged	x = Bit is unkr	nown	-n/n = Value at POR and BOR/Value at all other Resets						
'1' = Bit is set		'0' = Bit is clea	ared							
bit 7	LCxG2D4T: (	Gate 2 Data 4 T	rue (non-inve	rted) bit						
	1 = Icxd4T is gated into Icxg2									
bit 6		Gate 2 Data 4 I	logatod (invo	rtad) bit						
DILO	LUXU2D4N: Gate 2 Data 4 Negated (Inverted) bit									
	$\mu = 10x04N$ is gated into 10xg2 0 = 10xd4N is not gated into 10xg2									
bit 5	LCxG2D3T: (	Gate 2 Data 3 T	rue (non-inve	rted) bit						
	1 = lcxd3T is gated into lcxg2									
	0 = Icxd3T is not gated into Icxg2									
bit 4	LCxG2D3N: Gate 2 Data 3 Negated (inverted) bit									
	1 = lcxd3N is gated into lcxg2									
	0 = Icxd3N is not gated into Icxg2									
bit 3	LCxG2D2T: Gate 2 Data 2 True (non-inverted) bit									
	1 = Icxd2I is gated into Icxg2 0 = Icxd2T is pot gated into Icxg2									
hit 2	LCxG2D2N: Gate 2 Data 2 Negated (inverted) bit									
Sit 2	1 = lcxd2N is gated into lcxg2									
	0 = lcxd2N is not gated into lcxg2									
bit 1	LCxG2D1T: Gate 2 Data 1 True (non-inverted) bit									
	1 = Icxd1T is gated into Icxg2									
	0 = lcxd1T is	not gated into	lcxg2							
bit 0	LCxG2D1N:	Gate 2 Data 1 I	Negated (inver	rted) bit						
	1 = lcxd1N is	gated into lcxo	g2							
	0 = ICX01N IS	not gated into	icxg2							

#### REGISTER 24-6: CLCxGLS1: GATE 2 LOGIC SELECT REGISTER









Note 1:If the ADC clock source is selected as FRC, a time of TCY is added before the ADC clock starts. This allows the SLEEP instruction to be executed.



FIGURE 30-70: LFINTOSC FREQUENCY OVER VDD AND TEMPERATURE, PIC16LF1508/9 ONLY





#### 32.0 PACKAGING INFORMATION

#### 32.1 Package Marking Information



Legend	: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.
Note:	In the even be carried characters	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

\* Standard PICmicro<sup>®</sup> device marking consists of Microchip part number, year code, week code and traceability code. For PICmicro device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.